

Your Connection to Advanced PCB Manufacturing



Summit Interconnect is the largest, privately held PCB manufacturer in North America.

With multiple facilities and thousands of employees, Summit Interconnect offers a total PCB solution from quick-turn prototypes to volume production.

Manufacturing Expertise

With a customer-first culture, Summit's service teams and communication systems are in place to provide a best-in-class experience for our customers. Summit delivers the best manufacturing experience in the industry.

Quality You Can Trust

Quality PCB manufacturing is the top priority at Summit Interconnect. We hold the industry's highest certifications and meet critical industry standards including AS9100D, ISO 9001:2015, Nadcap, ITAR, RoHS, and many more.

Service That Over Delivers

When working with Summit, you get more than high-technology manufacturing. You get advice from real experts with hundreds of years of combined PCB experience, technical teams who oversee the entire manufacturing process, and above-and-beyond personal service to ensure complete satisfaction.

Summit provides a one-stop PCB manufacturing experience with the speed, reliability, and flexibility you need.





Products / Capabilities

Summit's continuous investment in technology provides each facility with advanced equipment and powerful software combined with the expertise to fabricate the most complex PCB designs.

Our highly advanced product line of PCBs include:



High Density Rigid PCBs

- High Layer Count
- Complex HDI Structures
- Conductive and Non-Conductive Via Fill
- Sequential Lamination
- Back Drilling
- Bonded Heat Sinks
- Embedded Coins
- Same-Day Turns Available

Flex and Rigid-Flex PCBs

- Double-Sided and Multi-Layer Flex
- Complex Rigid-Flex and Bookbinder Designs
- HDI Rigid-Flex
- Thin Flex Laminates
- Adhesiveless and Adhesive
- Stiffeners and Connectors
- Flex Assembly

RF/Microwave

- Wide Range of PTFE Materials
- RF/Digital Hybrid Designs
- Mixed Material Stackups
- Plated Cavities, Edge Plating
- High-Temp Lamination
- Mode Suppression Stitching
- Buried Resistors
- Edge Launch Features

Semiconductor/ATE

- Reference Cards, Probe Cards, DUT, Burn-in-Boards
- High Aspect Ratio
- Low-Loss Materials
- Bondable Gold
- Tight-Tolerance Drilling
- Sintering
- Oversized Panel Options

ANAHEIM FACILITY (Headquarters)
223 North Crescent Way
Anaheim, CA 92801
714 239 2433

CHICAGO FACILITY
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Schaumburg, IL 60193
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DENVER FACILITY
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 Aurora, CO 80011
 800 838 5650

OHOLLISTER FACILITY
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Hollister, CA 95023
831 636 7789

ORANGE FACILITY
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714 974 8590

SANTA ANA FACILITY
3506 W. Lake Center Dr. #A
Santa Ana, CA 92704
562 404 0626

SANTA CLARA FACILITY
1401 Martin Ave.
Santa Clara, CA 95050
877 264 0343

TORONTO FACILITY
 90 Don Park Road
 Markham, Ontario Canada L3R 1C4
 905 475 6658

500,000

Manufacturing sq footage

Line 1250+ Employees

ISO 9001:2015, ITAR Registered, ROHS Compliant, AS9100D, IPC 1791 Certification: 2021, Nadcap, MIL-PRF-31032, MIL-PRF-55110H, MIL-PRF-50884

For more information or a fast quote:

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